rohm

- STRUCTURE Silicon Monolithic Integrated Circuit
- ♦ PRODUCT I²C BUS Serial EEPROMs
- ♦ SERIES
- ♦ FAMILY BR24C□□ family
- ♦ TYPE
- ♦ PART NUMBER

BR24C□□-10□U-2.7

Supply voltage 2.7V~5.5V/Opreating temperature -40°C~+85°Ctype

ADVANTAGE SERIES

PART NUMBER	PACKAGE	DENSITY
BR24C01A -10SU-2.7		1Kbit
BR24C02N -10SU-2.7		2Kbit
BR24C04N -10SU-2.7	8−lead JEDECSOIC	4Kbit
BR24C08AN -10SU-2.7		8Kbit
BR24C16AN -10SU-2.7		16Kbit
BR24C32AN -10SU-2.7		32Kbit
BR24C64AN -10SU-2.7		64Kbit
BR24C01A -10TU-2.7		1Kbit
BR24C02 -10TU-2.7		2Kbit
BR24C04 -10TU-2.7	8–lead	4Kbit
BR24C08A -10TU-2.7	TSSOP	8Kbit
BR24C16A -10TU-2.7]	16Kbit
BR24C32A -10TU-2.7		32Kbit

♦ FEATURE

Two wire serial interface Endurance : 1,000,000 erase/write cycles Data retention : 100years Intial Data FFh in all address

♦ ABSOLUTE MAXIMUM RATING

Parameter	Symbol	Rating	Unit
Operating Temperature	Topr	-40~85	°C
Storage Temperature	Tstg	-65~125	°C
Voltage on Any Pin with Respect to Ground	-	-0.3~Vcc+0.3	v
Maximum Operating Voltage	Vcc	-0.3~6.5	v

♦ POWER DISSIPATION (Ta=25°C)

PACKAGE	Rating	Unit
8-lead JEDECSOIC	450 *1	mW
8-lead TSSOP	330 *2	mW

* Degradation is done at $4.5 \text{mW/}^{\circ}C(*1)$, $3.3 \text{mW/}^{\circ}C(*2)$ for operation above $25^{\circ}C$

REV.A

♦ DC OPERATING CHARACTERISTICS ecified Vcc=2 7V to 5 5V

Parameter	Symbol	Min	Max	Unit	Test Conditions
Supply Current Vcc=5.0V	I _{CC1}	-	1.0	mA	READ at 100 kHz
Supply Current Vcc=5.0V	I _{CC2}	-	3.0	mA	WRITE at 100 kHz
Standby Current Vcc=2.7V	I _{SB1}	-	4.0	μA	V _{IN} =V _{CC} or GND
Standby Current Vcc=5.0V	I _{SB2}	-	18.0	μA	V _{IN} ≖V _{CC} or GND
Input Leakage Current	lu	-	3.0	μA	V _{IN} =V _{CC} or GND
Output Leakage Current	لره	-	3.0	μA	Vout=Vcc or GND
input Low Level	V _{IL}	-	Vccx0.3	v	-
Input High Level	VIH	Vccx0.7	-	V	
Output Low Level Vcc=3.0V	VoL	-	0.4	v	loL=2.1mA

♦ AC OPERATING CHARACTERISTICS vise specified Vcc=2.7V to 5.5V A/164 Inlace

Parameter	0	2.7.		
Parameter	Symbol	Min	Max	- Unit
Clock Frequency, SCL	f _{SCL}	-	400	kHz
Clock Pulse Width Low	t _{LOW}	1.2	-	μs
Clock Pulse Width High	t _{HIGH}	0.6	-	μs
Noise Suppression Time	t,	-	50	ns
Clock Low to Data Out Valid	t _{AA}	0.1	0.9	μs
Time the bus must be free before a new transmission can start	t _{BUF}	1.2	-	μs
Start Hold Time	t _{hd.sta}	0.6	-	μs
Start Setup Time	t _{su.sta}	0.6	-	μs
Data in Hold Time	t _{HD.DAT}	0	-	μs
Data In Setup Time	t _{su.dat}	100	-	ns
Inputs Rise Time *1	t _R	-	0.3	μs
Inputs Fall Time *1	ţ.	-	300	ns
Stop Setup Time	t _{su.sto}	0.6	-	μs
Data Out Hold Time	t _{он}	50	-	ns
Write Cycle Time	t _{wR}	-	5	ms
Endurance *1 5.0V, 25°C	Endurance	1M	-	Write Cycle

BR24C32A/64A Unless otherwise specified,Vcc=2.7V to 5.5V, Ta=-40°C to 85°C

Parameter	Symbol	Min	Max	Unit	Test Conditions
Supply Current Vcc=5.0V	I _{CC1}		1.0	mA	READ at 400 kHz
Supply Current Vcc=5.0V	I _{CC2}	-	3.0	mA	WRITE at 400 kHz
Standby Current Vcc=2.7V	I _{SB1}	-	2.0	μA	V _{IN} =V _{CC} or GND
Standby Current Vcc=5.0V	l _{SB2}	-	6.0	μA	V _{IN} =V _{CC} or GND
Input Leakage Current	ես	-	3.0	μA	V _{IN} =V _{CC} or GND
Output Leakage Current	4.0	-	3.0	μA	V _{OUT} =V _{CC} or GND
Input Low Level	V _{IL}	-	Vccx0.3	v	-
Input High Level	VIH	Vccx0.7	-	v	-
Output Low Level Vcc=3.0V	VoL	-	0.4	V	l _{oL} =2.1mA

Clock Frequency, SCL f_{SCL} 400 1.3 *2 _ Clock Pulse Width Low t_{LOW} 1.2 *3 --Clock Pulse Width High t_{HIGH} 0.6 -Noise Suppression Time 50 ţ, Clock Low to Data Out Valid taa 0.1 0.9 1.3 *2 -Time the bus must be free before a new transmission can start tBUF 1.2 *3 -Start Hold Time 0.6 t_{hd.sta} -Start Setup Time 0.6 t_{SU.STA} -Data In Hold Time t_{hd.dat} 0 -Data In Setup Time 100 t_{SU.DAT} Inputs Rise Time *1 t_R 0.3 -Inputs Fall Time *1 t_F _ 300 Stop Setup Time 0.6 t_{su.sto} Data Out Hold Time ŧон 50 -

BR24C32A/64A Unless otherwise specified,Vcc=2.7V to 5.5V, Ta=-40°C to 85°C

Symbol

twr

Endurance

Parameter

2.7-5.0V

Max

Min

Unit

kHz

μs

μs

ns

μs

μs

μs

μs

μs

ns

μs

ns

μs

ns

ms

* Degradation is done at 4.5mW/°C(*1), 3.3mW/°C(*2)for operation above 25°C

OThis product is not designed for protection against

Write Cycles *1 Not 100% TESTED *2 BR24C32A

*3 BR24C64A

5

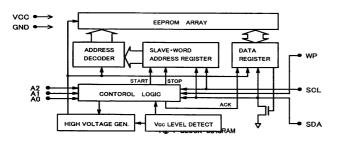
-

-

1M

♦ BLOCK DIAGRAM

radioactive rays.



♦ PIN No., PIN NAME

Write Cycle Time

Endurance *1 5.0V, 25°C

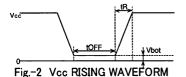
PIN No.	PIN NAME
1	A0
2	A1
3	A2
4	GND
5	SDA
6	SCL
7	WP
8	Vcc

rohm

♦NOTES FOR POWER SUPPLY

Vcc rises through the low voltage region in which internal circuit of IC and the controller are unstable, so that device may not work properly due to an incomplete reset of internal circuit. To prevent this, the device has the feature of P.O.R. and LVCC. In the case of power up, keep the following conditions to ensure functions of P.O.R. and LVCC.

- 1. It is necessary to be "SDA='H'" and "SCL='L' or 'H'".
- 2. Follow the recommended conditions of tR, tOFF, Vbot for the function of P.O.R. during power up.

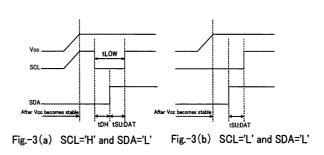


_		ED CONDITION	<u>S OF tR, tOFF, V</u> bot
	tR	tOFF	Vbot
ſ	Below 10ms	Above 10ms	Below 0.3V
ſ	Below 100ms	Above 10ms	Below 0.2V

 Prevent SDA and SCL from being "High-Z". In case that condition 1. and/or 2. cannot be met, take following actions.

A) Unable to keep condition 1.

- (SDA is "LOW" during power up.)
 - → Control SDA ,SCL to be "HIGH" as Fig.-3(a), 3(b).
- B) Unable to keep condition 2.
 - → After power becomes stable, execute software reset.
- C) Unable to keep both conditions 1 and 2.
 - \rightarrow Follow the instruction A first, then the instruction B.



♦ CAUTIONS ON USE

(1) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and action temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) GND electric potential

Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltage is lower than that of GND terminal.

(3) Thermal design

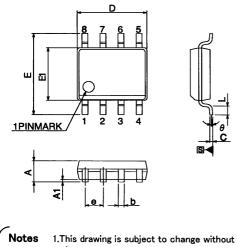
In consideration of permissible loss in actual use condition, carry out heat design with sufficient margin. (4) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(5) Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.



♦ PHYSICAL DIMENSION



notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference JEDEC MS-012 variation AA.

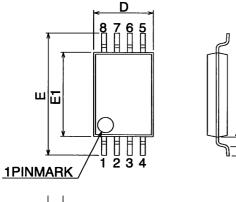


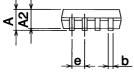
	au JEL	20001	01 400	age OIZ	C Data	
Symbol		mm			inches	
Symbol	Тур.	Min.	Max.	Тур.	Min.	Max.
Α	-	1.35	1.75	-	0.053	0.069
A1	-	0.10	0.25	-	0.004	0.010
b	-	0.31	0.51	-	0.012	0.020
с	-	0.17	0.25	-	0.007	0.010
D	-	4.80	5.00	-	0.189	0.197
e	1.27	_		0.050	_	_
G	BSC			BSC	_	_
E	-	5.79	6.20	-	0.228	0.244
E1	-	3.81	3.99	-	0.150	0.157
L	-	0.40	1.27	-	0.016	0.050
θ	-	0°	8°	-	0°	8°

♦ 8-lead JEDECSOIC Package Size Data

♦ 8-lead TSSOP Package Siz	e Data

Symbol		mm			inches	
Symbol	Тур.	Min.	Max.	Тур.	Min.	Max.
Α	_	-	1.20	-	-	0.047
A2	1.00	0.80	1.05	0.039	0.031	0.041
b	-	0.19	0.30	-	0.007	0.012
D	3.00	2.90	3.10	0.118	0.114	0.122
e	0.65	_	_	0.025	_	
9	BSC	_	-	0.025	-	-
Е	6.40	_		0.252		
	BSC		_	0.252	-	-
E1	4.40	4.30	4.50	0.173	0.169	0.177
L	0.60	0.45	0.75	0.023	0.017	0.030
L1	1.00		_	0.039		
	REF	-	-	0.039	_	-





Notes 1.This drawing is subject to change without notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference MO-153

Fig-5 8-lead TSSOP Package Outline

	Notes
	or reproduction of this document, in part or in whole, is permitted without the ROHM Co.,Ltd.
The content	specified herein is subject to change for improvement without notice.
"Products").	specified herein is for the purpose of introducing ROHM's products (hereinafte If you wish to use any such Product, please be sure to refer to the specifications e obtained from ROHM upon request.
illustrate the	application circuits, circuit constants and any other information contained hereir standard usage and operations of the Products. The peripheral conditions mus account when designing circuits for mass production.
However, sh	vas taken in ensuring the accuracy of the information specified in this document nould you incur any damage arising from any inaccuracy or misprint of such ROHM shall bear no responsibility for such damage.
examples or implicitly, an other parties	al information specified herein is intended only to show the typical functions of and f application circuits for the Products. ROHM does not grant you, explicitly o y license to use or exercise intellectual property or other rights held by ROHM and s. ROHM shall bear no responsibility whatsoever for any dispute arising from the technical information.
equipment c	es specified in this document are intended to be used with general-use electronic or devices (such as audio visual equipment, office-automation equipment, commu- ices, electronic appliances and amusement devices).
The Product	s specified in this document are not designed to be radiation tolerant.
	A always makes efforts to enhance the quality and reliability of its Products, a a fail or malfunction for a variety of reasons.
against the failure of any shall bear n	ure to implement in your equipment using the Products safety measures to guard possibility of physical injury, fire or any other damage caused in the event of the y Product, such as derating, redundancy, fire control and fail-safe designs. ROHM o responsibility whatsoever for your use of any Product outside of the prescribed t in accordance with the instruction manual.
system whic may result in instrument, controller or of the Produ	ts are not designed or manufactured to be used with any equipment, device or the requires an extremely high level of reliability the failure or malfunction of which in a direct threat to human life or create a risk of human injury (such as a medica transportation equipment, aerospace machinery, nuclear-reactor controller, fuel- other safety device). ROHM shall bear no responsibility in any way for use of any ucts for the above special purposes. If a Product is intended to be used for any I purpose, please contact a ROHM sales representative before purchasing.
be controlle	I to export or ship overseas any Product or technology specified herein that may d under the Foreign Exchange and the Foreign Trade Law, you will be required to nse or permit under the Law.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/